

FEATURES

- ☐ Digital Waveform Synthesis at 50 MHz
- ☐ 24-Bit Polar Phase Angle Accuracy
- User-selectable Waveform Synthesis, Frequency Modulation, or Phase Modulation.
- Amplitude Input for Amplitude Modulation and Gain Adjustment.
- ☐ Replaces Raytheon TMC2340A
- ☐ Available 100% Screened to MIL-STD-883, Class B
- ☐ Package Styles Available:
 - 120-pin Plastic Quad Flatpack
 - 120-pin Ceramic PGA

DESCRIPTION

The **L2340** is a digital synthesizer that performs waveform synthesis, modulation, and demodulation.

The L2340 automatically generates quadrature matched pairs of 16-bit sine and cosine waves in DAC-compatible 16-bit offset binary format with 15-bit amplitude and 32-bit phase inputs.

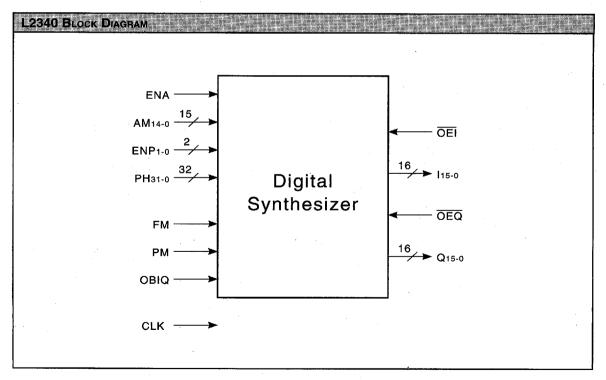
Output waveforms can be phase or frequency modulated. Digital output frequencies are restricted to the Nyquist limit.

Functional Description

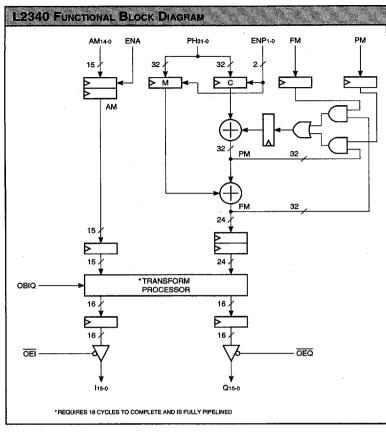
The L2340 converts Polar (Phase and Magnitude) data into Rectangular (Cartesian) coordinates. The user selects the numeric format. A valid transformed result is seen at the output after 22 clock cycles and will continue upon every clock cycle thereafter.

15-bit amplitude and 32-bit phase data are input into the L2340 to produce an output of 16-bit rectangular data. The user may select the data format to either 16-bit offset binary or 15-bit unsigned magnitude format. High accuracy phase increment values with minimal accumulation error is accomplished by use of a 32-bit phase accumulator.

The phase accumulator structure supports frequency or phase modulation and is selected by ENP1-0 and accumulator controls FM and PM.



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SIGNAL DEFINITIONS

Power

Vcc and GND

+5V power supply. All pins must be connected.

Clock

CLK - Master Clock

The rising edge of CLK strobes all enabled registers.

Inputs

AM14-0— Amplitude Modulation Data Input

AM14-0 is the 15-bit Amplitude Modulation Data input port. AM14-0 is latched on the rising edge of CLK.

PH31-0 — Phase Angle Data Input

PH31-0 is the 32-bit Phase Angle Data input port. Input phase accumulators are loaded through this port into registers enabled by ENP1-0. PH31-0 is latched on the rising edge of CLK.

Outputs

I15-0-x-coordinate Data Output

I15-0 is the 16-bit Cartesian x-coordinate Data output port. When $\overline{\text{OEI}}$ is HIGH, I15-0 is forced into the high-impedance state. I15 is forced HIGH if OBIQ is LOW.

Q15-0 — y-coordinate Data Output

Q15-0 is the 16-bit Cartesian y-coordinate Data output port. When $\overline{\text{OEQ}}$ is HIGH, Q15-0 is forced into the high-impedance state. Q15 is forced HIGH if OBIQ is LOW.

Controls

ENA — Amplitude Modulation Data Input Enable

When ENA is HIGH, AM is latched into the input register on the rising edge of clock. When ENA is LOW, the value stored in the register is unchanged.

ENP1-0 — Phase Modulation Data Input Control

ENP1-0 is the 2-bit Phase Modulation Data Input Control that determines one of the four modes shown in Table 1. 'M' is the Modulation Register and 'C' is the Carrier Register as shown in the Functional Block Diagram.

| TABLE | 1. REGISTER OPERATION |
|--------|------------------------------------------|
| ENP1-0 | Configuration |
| 0.0 | No registers enabled, current data held |
| 01 | M register input enabled, C data held |
| 10 | C register input enabled, M data held |
| 11 | M register = 0, C register input enabled |

| T | \BL! | 2. Accumulator Control |
|----|------|---------------------------------------|
| FΜ | РМ | Configuration |
| 0 | 0 | No accumulation (normal operation) |
| 0 | 1 | PM accumulator path enabled |
| 1 | 0 | FM accumulator path enabled |
| 1 | 1 | Logical OR of PM and FM (Nonsensical) |

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Digital Synthesizer

FM, PM — Frequency Modulation, Phase Modulation Control

FM and PM is the 2-bit Frequency Modulation/Phase Modulation Control that determines one of the four modes shown in Table 2. When full-scale is exceeded, the accumulator will roll over correctly allowing continuous phase accumulation through 2π radians.

OBIQ — Data Input/Output Format Select

When OBIQ is HIGH, offset binary format is selected. When OBIQ is LOW, unsigned format is selected.

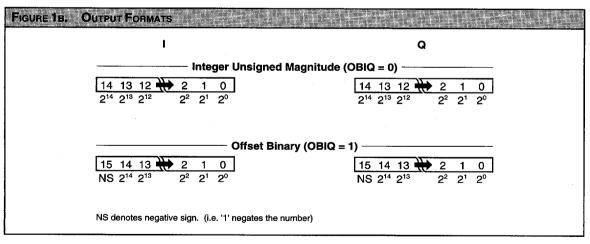
OEI — x-coordinate Data Output Enable

When \overline{OEI} is LOW, I15-0 is enabled for data output. When \overline{OEI} is HIGH, I15-0 is placed in a high-impedance state.

OEQ — y-coordinate Data Output Enable

When \overline{OEQ} is LOW, Q15-0 is enabled for data output. When \overline{OEQ} is HIGH, Q15-0 is placed in a high-impedance state.

| NPUT FORMATS | |
|------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------|
| AM | PH |
| | RTP = 0) |
| Integer Unsigned Magnitude | Fract. Unsigned Mag./Two's Comp. |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ |
| *±2 ⁰ denotes two's complement sign or higher and phase accumulator is modulo 2 ³² , this bit | st magnitude bit. Since phase angles are modulo 2π may be recarded as $\pm\pi$. |



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Circle Test

When performing a coordinate transformation, inaccuracies are introduced by a combination of quantization and approximation errors. The accuracy of a coordinate transformer is dependent on the word length used for the input variables, the word length used for internal calculations, as well as the number of iterations or steps performed. Truncation errors are due to the finite word length and approximation errors are due to the finite number of iterations. For example, in the case of performing a polar-torectangular transformation, the accuracy of the rotation will be determined by how closely the input rotation angle was approximated by the summation of sub-rotation angles.

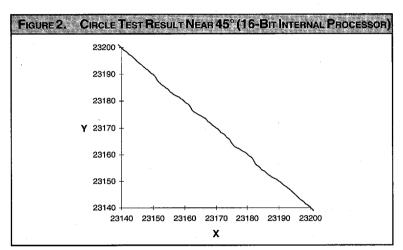
In this study, we compare how accurately a coordinate transformer with a 16-bit internal processor versus a 24-bit internal processor can calculate all the coordinates of a circle. By setting the radius to 7FFFH, θ is incremented using the accumulator of the L2340 in steps of 0000 4000H until all the points of a full circle are calculated into rectangular coordinates.

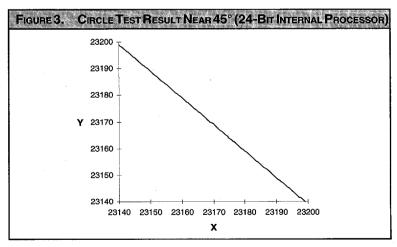
The resulting rectangular coordinates were plotted and graphed. A graphical representation of the resulting vectors for both 16-bit and 24-bit internal processors are compared at 45°. Theoretically, a perfect circle is the desired output but when the resulting vectors from a coordinate transformer with 16-bit internal processor are graphed and displayed as shown in Figure 2, we see significant errors due to the inherent properties of a digital synthesizer. In comparison, the 24-bit internal processor proves to be significantly more accurate than a 16-bit internal processor due to minimization of truncation errors. In many applications, this margin of error will

introduce noise when performing waveform sythesis, modulation, and demodulation.

Data values for Figure 2 and Figure 3 are shown in Table 3. By looking at these values, we observe the step resolution on a 16-bit internal processor is not 1 unit in the x and y. In most cases, the minimum step resolution is 2 units in the x and y. On the other hand, step resolution on a 24-bit internal processor is 1 unit in the x and y thus resulting in greater accuracy.

The minimum theoretical angle resolution that could be produced is 0.00175° when x=7FFFH and y=1H. A 16-bit internal processor can produce a minimum angle resolution of only 0.00549° and will not be able to properly calculate the theoretical minimum angle resolution. On the other hand, a 24-bit internal processor can produce a minimum angle resolution of 0.00002° and could therefore properly calculate the theoretical minimum angle resolution.





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| | 3. Resu | | | s Of Cit | CLE TEST | NEAR 4 | 50 | | |
|-------|---------------------------|-------|---------|----------------|---------------------------|--------|------|--|--|
| 1 | 16-bit Internal Processor | | | | 24-bit Internal Processor | | | | |
| x | x (HEX) | у | y (HEX) | x x(HEX) y y(H | | | | | |
| 23201 | 5AA1 | 23139 | 5A63 | 23199 | 5A9F | 23140 | 5A64 | | |
| 23199 | 5A9F | 23141 | 5A65 | 23198 | 5A9E | 23141 | 5A65 | | |
| 23199 | 5A9F | 23141 | 5A65 | 23198 | 5A9E | 23141 | 5A65 | | |
| 23199 | 5A9F | 23141 | 5A65 | 23197 | 5A9D | 23142 | 5A66 | | |
| 23199 | 5A9F | 23141 | 5A65 | 23197 | 5A9D | 23142 | 5A66 | | |
| 23197 | 5A9D | 23143 | 5A67 | 23196 | 5A9C | 23143 | 5A67 | | |
| 23197 | 5A9D | 23143 | 5A67 | 23196 | 5A9C | 23143 | 5A67 | | |
| 23197 | 5A9D | 23143 | 5A67 | 23195 | 5A9B | 23144 | 5A68 | | |
| 23197 | 5A9D | 23143 | 5A67 | 23194 | 5A9A | 23145 | 5A69 | | |
| 23195 | 5A9B | 23145 | 5A69 | 23194 | 5A9A | 23145 | 5A69 | | |
| 23195 | 5A9B | 23145 | 5A69 | 23194 | 5A9A | 23145 | 5A69 | | |
| 23195 | 5A9B | 23145 | 5A69 | 23193 | 5A99 | 23146 | 5A6A | | |
| 23195 | 5A9B | 23145 | 5A69 | 23192 | 5A98 | 23147 | 5A6B | | |
| 23192 | 5A98 | 23148 | 5A6C | 23191 | 5A97 | 23148 | 5A6C | | |
| 23192 | 5A98 | 03148 | 5A6C | 23191 | 5A97 | 23148 | 5A6C | | |
| 23192 | 5A98 | 23148 | 5A6C | 23191 | 5A97 | 23148 | 5A6C | | |
| 23192 | 5A98 | 23148 | 5A6C | 23190 | 5A96 | 23149 | 5A6D | | |
| 23190 | 5A96 | 23150 | 5A6E | 23189 | 5A95 | 23150 | 5A6E | | |
| 23190 | 5A96 | 23150 | 5A6E | 23189 | 5A95 | 23150 | 5A6E | | |
| 23190 | 5A96 | 23150 | 5A6E | 23189 | 5A95 | 23150 | 5A6E | | |
| 23190 | 5A96 | 23150 | 5A6E | 23188 | 5A94 | 23151 | 5A6F | | |
| 23187 | 5A93 | 23152 | 5A70 | 23187 | 5A93 | 23152 | 5A70 | | |
| 23187 | 5A93 | 23152 | 5A70 | 23186 | 5A92 | 23153 | 5A71 | | |
| 23187 | 5A93 | 23152 | 5A70 | 23186 | 5A92 | 23153 | 5A71 | | |
| 23187 | 5A93 | 23152 | 5A70 | 23186 | 5A92 | 23153 | 5A71 | | |
| 23185 | 5A91 | 23154 | 5A72 | 23185 | 5A91 | 23154 | 5A72 | | |
| 23185 | 5A91 | 23154 | 5A72 | 23184 | 5A90 | 23155 | 5A73 | | |
| 23185 | 5A91 | 23154 | 5A72 | 23184 | 5A90 | 23155 | 5A73 | | |
| 23185 | 5A91 | 23154 | 5A72 | 23184 | 5A90 | 23155 | 5A73 | | |
| 23183 | 5A8F | 23156 | 5A74 | 23183 | 5A8F | 23156 | 5A74 | | |



| Storage temperature | 65°C to +150°C |
|-------------------------------------------|----------------|
| Operating ambient temperature | 55°C to +125°C |
| Vcc supply voltage with respect to ground | |
| Input signal with respect to ground | |
| Signal applied to high impedance output | |
| Output current into low outputs | |
| Latchup current | |

| SECTION AND ADDRESS OF | OPERATING CONDITIONS To meet speci | ified electrical and switching character | istics |
|------------------------|------------------------------------|------------------------------------------|-------------------------------|
| ſ | Mode | Temperature Range(Ambient) | Supply Voltage |
| ļ | Active Operation, Commercial | 0°C to +70°C | 4.75 V ≤ V CC ≤ 5.25 V |
| ı | Active Operation Military | -55°C to +125°C | 4.50 V ≤ VCC ≤ 5.50 V |

| ELECTRIC | CAL CHARACTERISTICS Ove | er Operating Conditions (Note 4) | Carlos Garage | | | 6.1 <u>1</u> |
|-------------|-------------------------|----------------------------------|------------------|-----|-------------|--------------|
| Symbol | Parameter | Test Condition | Min | Тур | Max | Unit |
| V OH | Output High Voltage | Vcc = Min., IoH = -2.0 mA | 2.4 | | | ٧ |
| V OL | Output Low Voltage | Vcc = Min., IoL = 4.0 mA | | | 0.4 | ٧ |
| V iH | Input High Voltage | | 2.0 | | V cc | ٧ |
| V IL | Input Low Voltage | (Note 3) | 0.0 | | 0.8 | V |
| lix | InputCurrent | Ground ≤ Vin ≤ VCC (Note 12) | | | ±10 | μA |
| loz | Output Leakage Current | Ground ≤ VOUT ≤ VCC (Note 12) | | | ±10 | μА |
| ICC1 | Vcc Current, Dynamic | (Notes 5, 6) | | | 95 | mA |
| ICC2 | Vcc Current, Quiescent | (Note 7) | | | 5 | mA |
| CIN | Input Capacitance | T _A = 25°C, f = 1 MHz | | | 10 | pF |
| Соит | Output Capacitance | T _A = 25°C, f = 1 MHz | | | 10 | pF |

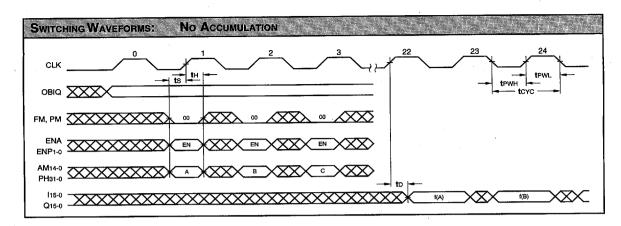


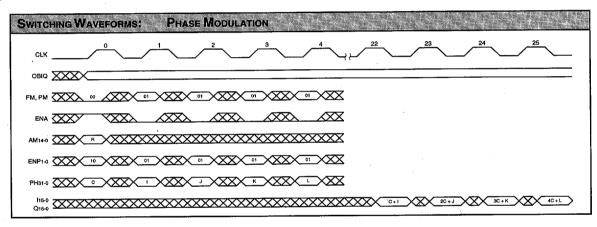
SWITCHING CHARACTERISTICS

| Сомме | RCIAL OPERATING RANGE (0°C to +70°C) Notes | 9, 10 (ns) | | | | | 1947 - Silvi | |
|--------------|--------------------------------------------|------------|-----|-----|-----|-----|--------------|--|
| | | L2340- | | | | | | |
| | | | 50 | | 25 | | 20 | |
| Symbol | Parameter | Min | Max | Min | Max | Min | Max | |
| tcyc | Cycle Time | 50 | | 25 | | 20 | | |
| t PWL | Clock Pulse Width Low | 10 | | 8 | | 7 | | |
| t PWH | Clock Pulse Width High | 8 | | 7 | | 6 | | |
| ts | Input Setup Time | 12 | | 7 | | 6 | | |
| tн | Input Hold Time | 1 | | 0 | | 0 | | |
| to | Output Delay | | 22 | | 18 | | 16 | |
| t ENA | Three-State Output Enable Delay (Note 11) | | 13 | | 13 | | 13 | |
| tDIS | Three-State Output Disable Delay (Note 11) | | 13 | | 13 | | 13 | |

| | Parameter | L2340- | | | | | | |
|--------------|--------------------------------------------|--------|-----|-------------------------------------|-----|-----|-----|--|
| | | 5 | 50 | | 25 | | 20 | |
| Symbol | | Min | Max | Min | Max | Min | Max | |
| tcyc | Cycle Time | 50 | | 25 | | 20 | | |
| t PWL | Clock Pulse Width Low | 11 | | 9 | | 7 | | |
| t PWH | Clock Pulse Width High | 8 | | 7 | | 6 | | |
| ts | Input Setup Time | 13 | | 7 | | 6 | | |
| t⊢ | Input Hold Time | 2 | | 2 | | 1 | | |
| t D | Output Delay | | 25 | · · · · · · · · · · · · · · · · · · | 20 | | 18 | |
| t ENA | Three-State Output Enable Delay (Note 11) | | 15 | | 14 | | 13 | |
| tDIS | Three-State Output Disable Delay (Note 11) | | 15 | | 14 | | 13 | |







NOTES

- 1. Maximum Ratings indicate stress specifications only. Functional operation of these products at values beyond those indicated in the Operating Conditions table is not implied. Exposure to maximum rating conditions for extended periods may affect reliability.
- 2. The products described by this specification include internal circuitry designed to protect the chipfrom damaging substrate injection currents and accumulations of static charge. Nevertheless, conventional precautions should be observed during storage, handling, and use of these circuits in order to avoid exposure to excessive electrical stress values.
- 3. This device provides hard clamping of transient undershoot and overshoot. Input levels below ground or above VCC will be clamped beginning at-0.6 V and VCC + 0.6 V. The device can withstand indefinite operation with inputs in the range of -0.5 V to +7.0 V. Device operation will not be adversely affected, however, input current levels will be well in excess of 100 mA.
- 4. Actual test conditions may vary from those designated but operation is guaranteed as specified.
- 5. Supply current for a given application can be accurately approximated by:

where

N = total number of device outputs

C = capacitive load per output

V = supply voltage

 $F = \operatorname{clock} \operatorname{frequency}$

- 6. Tested with all outputs changing every cycle and no load, at a 20 MHz clock rate.
- 7. Tested with all inputs within 0.1 V of VCC or Ground, no load.
- 8. These parameters are guaranteed but not 100% tested.

9. AC specifications are tested with input transition times less than 3 ns, output reference levels of 1.5 V (except tDIS test), and input levels of nominally 0 to 3.0 V. Output loading may be a resistive divider which provides for specified IOH and IOL at an output voltage of VOH min and VOL max respectively. Alternatively, a diode bridge with upper and lower current sources of IOH and IOL respectively, and a balancing voltage of 1.5 V may be used. Parasitic capacitance is 30 pF minimum, and may be distributed.

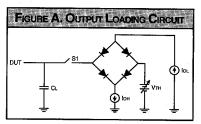
This device has high-speed outputs capable of large instantaneous current pulses and fast turn-on/turn-off times. As a result, care must be exercised in the testing of this device. The following measures are recommended:

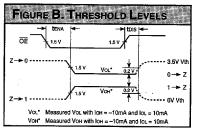
- a. A 0.1 µF ceramic capacitor should be installed between VCC and Ground leads as close to the Device Under Test (DUT) as possible. Similar capacitors should be installed between device VCC and the tester common, and device ground and tester common.
- b. Ground and VCC supply planes must be brought directly to the DUT socket or contactor fingers.
- c. Input voltages should be adjusted to compensate for inductive ground and VCC noise to maintain required DUT input levels relative to the DUT ground pin.
- 10. Each parameter is shown as a minimum or maximum value. Input requirements are specified from the point of view of the external system driving the chip. Setup time, for example, is specified as a minimum since the external system must supply at least that much time to meet the worst-case requirements of all parts. Responses from the internal circuitry are specified from the point of view of the device. Output delay, for example, is specified as a maximum since worstcase operation of any device always provides data within that time.

11. For the tENA test, the transition is measured to the 1.5 V crossing point with datasheet loads. For the tDIS test, the transition is measured to the ±200mV level from the measured steady-state output voltage with ±10mA loads. The balancing voltage, VTH, is set at 3.5 V for Z-to-0 and 0-to-Z tests, and set at 0 V for Z-to-1 and 1-to-Z tests.

Digital Synthesizer

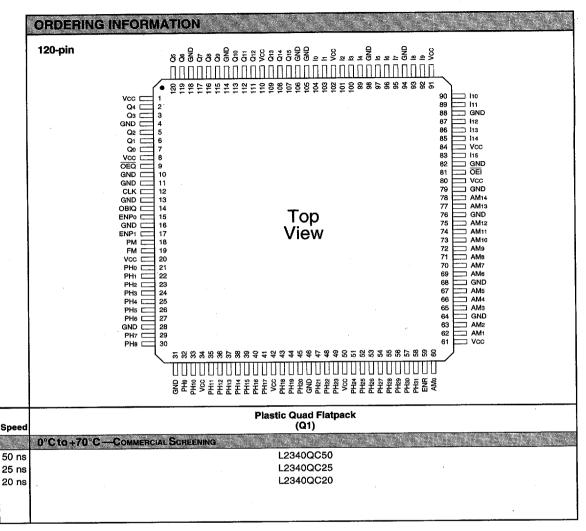
12. These parameters are only tested at the high temperature extreme, which is the worst case for leakage current.

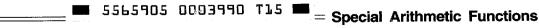




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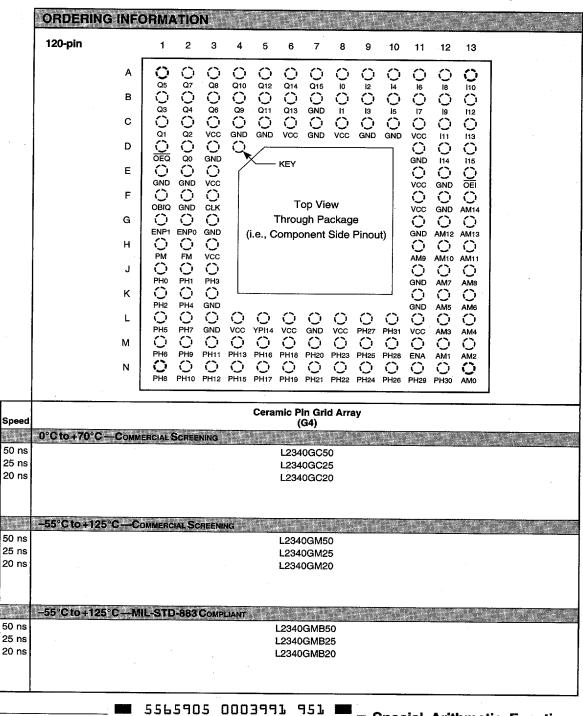








Digital Synthesizer



Special Arithmetic Functions